

# Product Change Notification

The information below reflects a change that is being implemented.

Notice Date: 10/19/2007

Product Category: 24xxx

Notification Subject: CCB#776.01-776.02:  
QUALIFICATION OF 3 STACKED  
DIE IN 8L SOIJ .208" (CCB#776.01)  
AND 8L PDIP .300" (CCB#776.02)  
PACKAGES AT MTAI

Notification Body:

Microchip Part#s Affected:  
24AA1025  
24LC1025  
24FC1025

Description of Change:  
NEW ASSEMBLY SITE

Impacts to Data Sheet:  
NONE

Reason for Change:  
TO INCREASE MANUFACTURING CAPACITY

Estimated Change Implementation Date(s):  
NOVEMBER 9, 2007

Markings to Distinguish Revised From Unrevised Devices:  
(e.g.: Date Code, Device Marking, Ship Container Marking)  
TRACEBILITY CODE